upplier Informa	IPC Web Site for Inform http://www.ipc.org/IPC		undard	Form Type * Distribute		laration Class *						
	tion				Clas	als and Mfg Informatio	ials and Mfg Information					
omnany name*							,					
Company name*			Company unique ID		Unique ID Authority			Response Date*				
onsemi								2024-05-16				
Contact Name Title			Title - Contact		Phone - Contac	Phone - Contact*			Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance		NA	NA			Product-Env-Stewards@onsemi.com			
Authorized Representative* Title			Title - Representative		Phone - Repres	Phone - Representative*			Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com				
Requester 1	tem Number	Mfr Item Number	Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type		
	1PMT		921BT1G ZEN PWMITE REG 3.2V		2024-05-16		MY1	16.3	mg	Each		
	roccess Information		- All	STD-020 MSL Rating	Deals Brees	D. J. T	Mar Time of Publish	T Number	or of Deflect Co			
			·									
•	Sn) - anneaied	CU Alloy	I		200	<u> </u>	30	seconds 3				
omments			20									
	e at peak temperature or regarding material con	8 8										

RoHS Material Composition Declaration			Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominal contains a RoHS restricted substance inexcess encompass all such components. Supplier certi as of the date that Supplier completes this for Company acknowledges that Supplier may ha independently verified information provided by certification in this paragraph. If the Company	ted biphenyls and/or polybrominated diphenyls of an applicable quantity limit, please indication in the graph of an applicable quantity limit, please indications. Supplier acknowledges that Company will we relied on information provided by others in a minimum and the Supplier agrees that, at a minimum and the Supplier enter into a written agreem source of the Supplier's liability and the Company of the Supplier's liability and the Supplier's liability and the Supplier's liability and the Company of the Supplier's liability and the Supplier's liabi	J 2011/65/EU and implemented by the laws of the Eyl ethers (each a "RoHS restricted substance") in exate below which, if any, RoHS exemption you belie les in this form using appropriate methods to ensure rely on this certification in determining the complian completing this form, and that Supplier may not ha, its suppliers have provided certifications regarding tent with respect to the identified part, the terms and impany's remedies for issues that arise regarding info cable to such part shall apply.	cess of the applicable quantity limit identified ab we may apply. If the part is an assembly with low its accuracy and that such information is true an- unce of its products with European Union member ave independently verified such information. Ho their contributions to the part, and those certifications conditions of that agreement, including any warr	ove. If a homogeneous material within the part ver level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		'Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	astislav Drska	-6_							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.16	mg	Supplier	Silicon (Si)	7440-21-3		0.16	mg
Die Attach Solder	0.34		Supplier	Silver (Ag)	7440-22-4		0.0085	mg
			A	Lead (Pb)	7439-92-1	7a	0.3145	mg
			Supplier	Tin (Sn)	7440-31-5		0.017	mg
Lead Frame	5.38	mg	Supplier	Zinc (Zn)	7440-66-6		0.0054	mg
			Supplier	Iron (Fe)	7439-89-6		0.1291	mg
			Supplier	Copper (Cu)	7440-50-8		5.2455	mg
Mold Compound-Black	9.69		Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.969	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0484	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		1.405	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6.2985	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.969	mg
Plating	0.73	mg	Supplier	Tin (Sn)	7440-31-5		0.73	mg